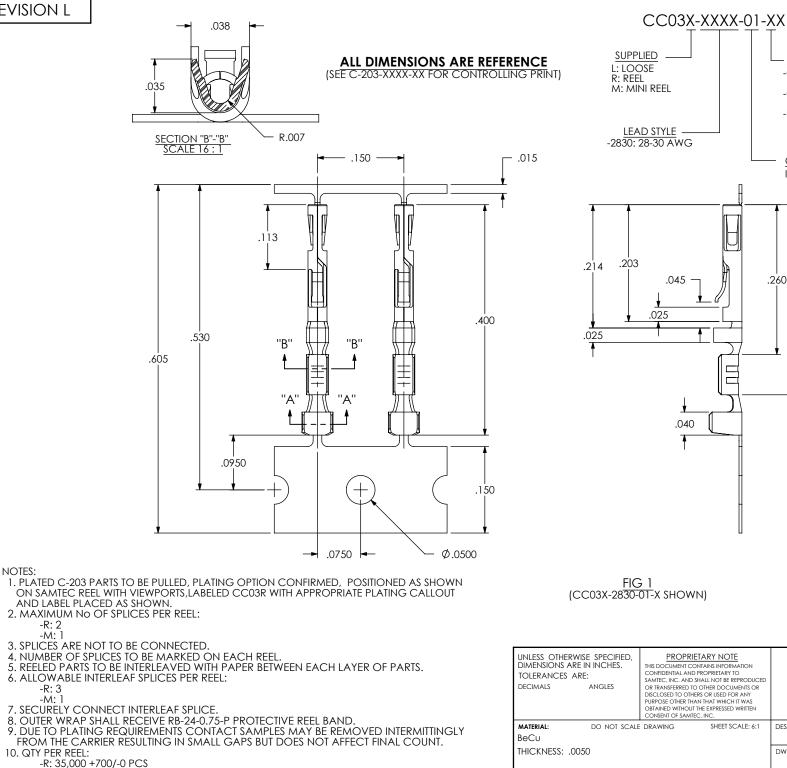
REVISION L

-M: 5,000 +300/-0 PCS



PLATING SPECIFICATION -GF: 3µ" FLASH SELECTIVE IN CONTACT AREA, 3µ" GOLD ON TAIL -G: 10u" LIGHT GOLD IN CONTACT AREA. 3µ" GOLD ON TAIL -H: 30µ" HEAVY GOLD IN CONTACT AREA, 3" GOLD ON TAIL OPTION **INSULATION THICKNESS:** .260 .330 .054 .057 SECTION "A"-"A" R.014 SCALE 16:1 PROPRIETARY NOTE THIS DOCUMENT CONTAINS INFORMATION CONFIDENTIAL AND PROPRIETARY TO SAMTEC, INC. AND SHALL NOT BE REPRODUCED OR TRANSFERRED TO OTHER DOCUMENTS OR DISCLOSED TO OTHERS OR USED FOR ANY 520 PARK EAST BLVD, NEW ALBANY, IN 47150 PURPOSE OTHER THAN THAT WHICH IT WAS PHONE: 812-944-6733 FAX: 812-948-5047 OBTAINED WITHOUT THE EXPRESSED WRITTEN e-Mail: info@SAMTEC.com code: 55322 SHEET SCALE: 6:1 DESCRIPTION .050" C.L. DISCRETE WIRE CONTACT

DWG. NO

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BY: BRATCHER 3/8/2005

CC03X-XXXX-01-XX

SHEET 1 OF 2

